ATI LOW EMI CLOCK GENERATOR

MK1705A

Description

The MK1705A generates a low EMI output clock from a clock or crystal input. The part is designed to dither the LCD interface clock or other clocks for ATI's flat panel graphics controllers. The MK1705A uses IDT's proprietary mixture of analog and digital Phase Locked Loop (PLL) technology to synthesize the frequency. It also uses IDT's patented technique to spread the frequency spectrum of the output, thereby reducing the frequency amplitude peaks by several dB.

The MK1705A is designed to have the output spread centered around the input frequency. Refer to the MK1704A for spreading down from the input frequency or the MK1714-0x for a crystal input and the widest selection of spread rates and multipliers.

IDT offers many other clocks for computers and computer peripherals. Consult IDT when you need to remove crystals and oscillators from your board.

Note: When changing input frequency, the LEE pin must be set low for a minimum of 10μS to allow the PLL to lock to the new frequency. Alternatively, the $\overline{PD}$ pin maybe be set low while changing frequencies.

Features

- 8-pin SOIC package
- Provides a spread spectrum output clock
- Supports ATI's flat panel controllers
- Accepts a clock input, provides same frequency dithered output
- Good for all VGA modes from 40 to 167 MHz
- Peak reduction by 7 dB - 14 dB typical on 3rd - 19th odd harmonics
- Low EMI feature can be disabled
- Operating voltage of 3.3 V or 5 V
- Advanced, low power CMOS process

Block Diagram

Pin Assignment

8 pin (150 mil) SOIC
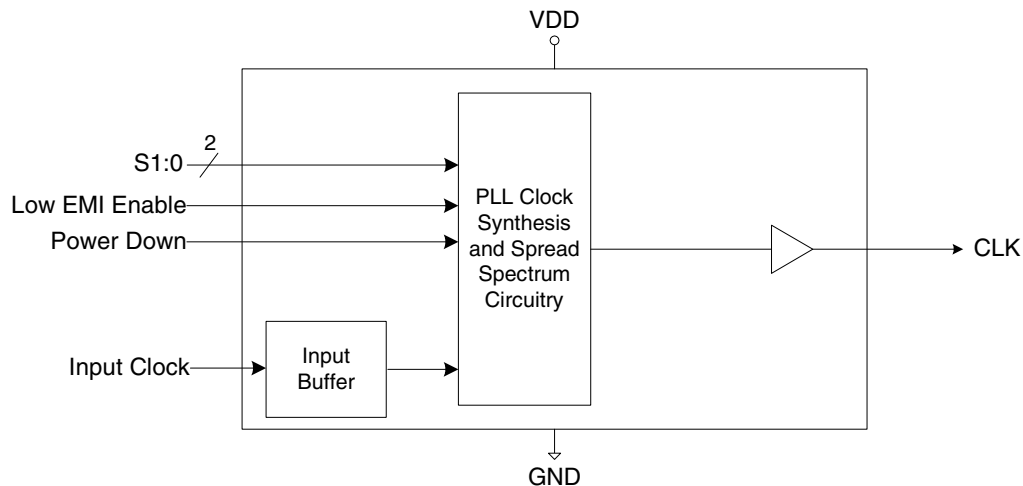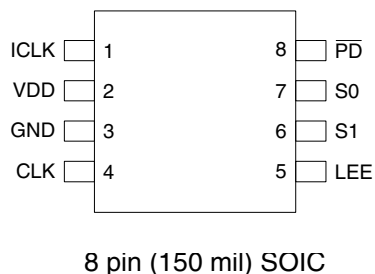
Output Clock Selection Table

S1 pin 6	S0 pin 7	Input/Output Range pin 1/pin 4	Frequency Spread vs. CLK
0	0	40 to 167 MHz	Center ±1.25%
0	1	60 to 167 MHz	Center ±0.5%
1	0	Test	Test
1	1	40 to 100 MHz	Center ±1%

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	ICLK	XI	Connect to a clock input as shown in table above.
2	VDD	Power	Connect to +3.3 V or +5 V.
3	GND	Power	Connect to ground.
4	CLK	Output	Clock output equal to input frequency.
5	LEE	Input	Low EMI enable. Turns on the spread spectrum when high. Internal pull-up.
6	S1	Input	Frequency select 1 input. Selects input/output clock range per table above. Internal pull-up.
7	S0	Input	Frequency select 0 input. Selects input/output clock range per table above. Internal pull-up.
8	$\overline{PD}$	Input	Power down. Stops output low when this pin is low. Internal pull-up.

External Components

Series Termination Resistor

Clock output traces over one inch should use series termination. To series terminate a 50Ω trace (a commonly used trace impedance), place a 33Ω resistor in series with the clock line, as close to the clock output pin as possible. The nominal impedance of the clock output is 20Ω

Decoupling Capacitor

A decoupling capacitor of 0.01µF must be connected

between VDD and GND on pins 2 and 3 as close to the chip as possible.

PCB Layout Recommendations

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

1) The 0.01µF decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as

possible. No vias should be used between decoupling capacitor and VDD pin. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via. Distance of the ferrite bead and bulk decoupling from the device is less critical.

2) The external crystal should be mounted just next to the device with short traces. The X1 and X2 traces should not be routed next to each other with minimum spaces, instead they should be separated and away from other traces.

3) To minimize EMI the 33Ω series termination resistor, if needed, should be placed close to the clock output.

4) An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers. Other signal traces should be routed away from the MK1705A. This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the MK1705A. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	7 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature	0 to +70° C
Storage Temperature	-65 to +150° C
Junction Temperature	125° C
Soldering Temperature	260° C

Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature	0		+70	° C
Power Supply Voltage (measured in respect to GND)	+3.0		+5.5	V

DC Electrical Characteristics

Unless stated otherwise, VDD = 5 V, Ambient Temperature 0 to +70° C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.0		5.5	V
Supply Current	IDD	No load, 3.3V		20		mA
		No load, 5V		15		mA
Input High Voltage	V_{IH}	Clock input	(VDD/2)+1	VDD/2		V
Input Low Voltage	V_{IL}	Clock input		VDD/2	(VDD/2)-1	V
Output High Voltage	V_{OH}	I_{OH} = -4 mA	VDD-0.4			V
Output High Voltage	V_{OH}	I_{OH} = -25 mA	2.4			V
Output Low Voltage	V_{OL}	I_{OL} = 25 mA			0.4	V
Input Capacitance	C_{IN}	S0 pin		7		pF
Nominal Output Impedance	Z_{OUT}			20		Ω
Internal Pull-up Resistor	R_{PU}	LEE pin only		500		kΩ

AC Electrical Characteristics

Unless stated otherwise, VDD = 5 V, Ambient Temperature 0 to +70° C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			40		167	MHz
Input Clock Duty Cycle		Time above VDD/2	20		80	%
Output Rise Time	t_{OR}	0.8 to 2.0 V, Note 1			1.5	ns
Output Fall Time	t_{OF}	2.0 to 0.8 V, Note 1			1.5	ns
Output Clock Duty Cycle		Time above 1.5 V	40	50	60	%
Output Clock Frequency Variation from Mean		LEE high	±0.5		2.5	%
EMI Peak Frequency Reduction		3rd - 19th odd harmonics	7		14	dB

Note 1: Measured with 15 pF load.

Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	θ_{JA}	Still air		150		° C/W
	θ_{JA}	1 m/s air flow		140		° C/W
	θ_{JA}	3 m/s air flow		120		° C/W
Thermal Resistance Junction to Case	θ_{JC}			40		° C/W

Package Outline and Package Dimensions (8-pin SOIC, 150 Mil. Body)

Package dimensions are kept current with JEDEC Publication No. 95

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	1.35	1.75	.0532	.0688
A1	0.10	0.25	.0040	.0098
B	0.33	0.51	.013	.020
C	0.19	0.25	.0075	.0098
D	4.80	5.00	.1890	.1968
E	3.80	4.00	.1497	.1574
e	1.27 BASIC		0.050 BASIC	
H	5.80	6.20	.2284	.2440
h	0.25	0.50	.010	.020
L	0.40	1.27	.016	.050
α	0°	8°	0°	8°
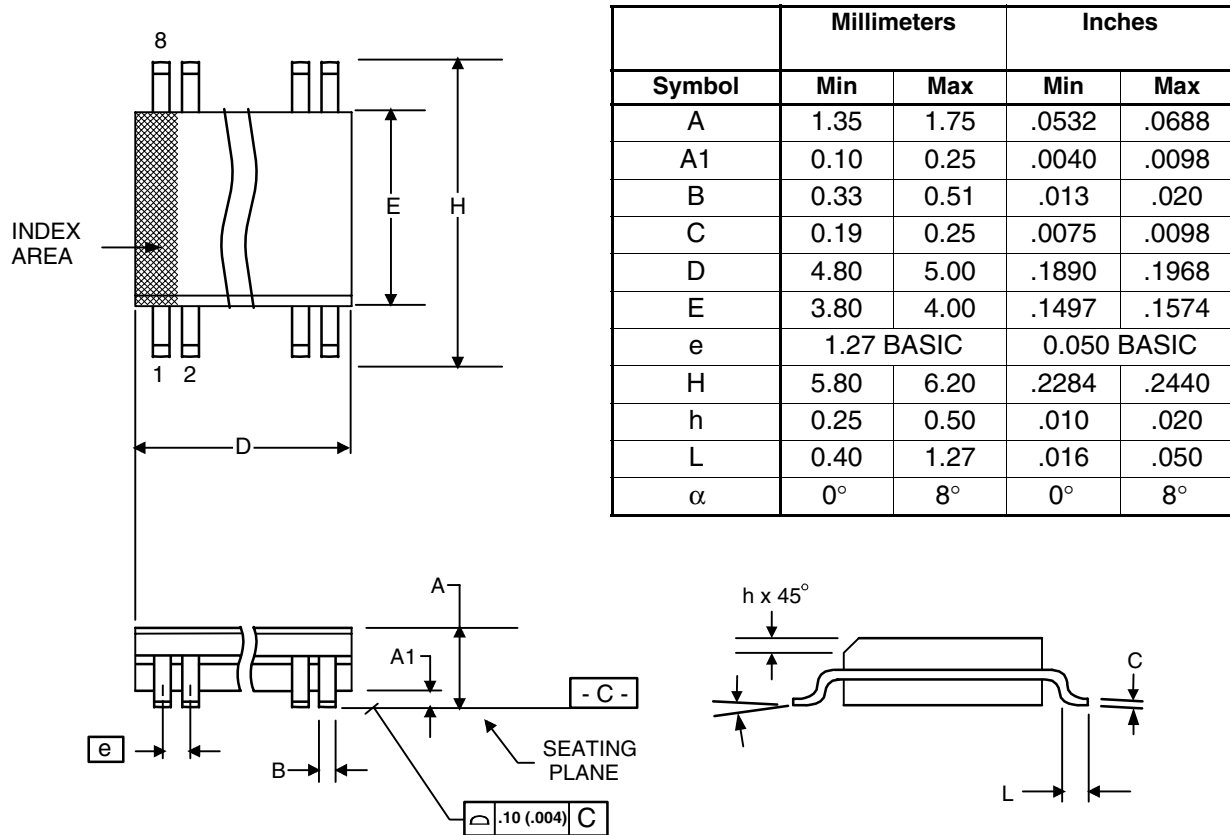
Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
MK1705A	MK1705A	Tubes	8-pin SOIC	0 to +70° C
MK1705ATR	MK1705A	Tape and Reel	8-pin SOIC	0 to +70° C
MK1705ALF	MK1705AL	Tubes	8-pin SOIC	0 to +70° C
MK1705ATRLF	MK1705AL	Tape and Reel	8-pin SOIC	0 to +70° C

Parts that are ordered with a "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Device Technology (IDT) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

IMPORTANT NOTICE AND DISCLAIMER

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Trademarks

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit www.renesas.com/contact-us/.